



PATENT

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IN THE UNITED STATES PATENT AND
TRADEMARK OFFICE In re Reissue
Application of

PAI-HSIANG KAO, et al.

Patent No. 6,023,094

Issued: February 8, 2000

Reissue Application No. 10/022,683

Filed: December 17, 2001

For: **SEMICONDUCTOR WAFER
HAVING A BOTTOM SURFACE
PROTECTIVE COATING**

Group Art Unit: 2815

Examiner: Sheila Clark

**TRANSMITTAL FORWARDING
ORIGINAL LETTERS PATENT**

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 24, 2004.

GIRARD & EQUITZ LLP

Date: 08/24/04

By:

Jacob S. Zweig

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In a recent telephone conference, Examiner Sheila Clark indicated that the subject application is in condition for allowance and requested that the original Letters Patent be returned. Enclosed, please find enclosed the above-referenced Letters Patent.

The Commissioner is hereby authorized to charge payment of any **additional** fees associated with this communication, or credit any overpayment to Deposit Account No. 50-1697. **A duplicate copy of this sheet is enclosed.**

Respectfully submitted,

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By: 

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Dated: 8/24/04

Attorney Docket No. NSC1-G9900

Attorneys for Applicant(s)